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Kind regards,

Team Nexperia

PDTD123T series

NPN 500 mA, 50 V resistor-equipped transistors; R1 = 2.2 k Ω , R2 = open

Rev. 03 — 16 November 2009

Product data sheet

1. Product profile

1.1 General description

500 mA NPN Resistor-Equipped Transistors (RET) family.

Table 1. Product overview

| Type number | Package | | | PNP complement |
|--------------|---------|--------|----------|----------------|
| | NXP | JEITA | JEDEC | |
| PDTD123TK | SOT346 | SC-59A | TO-236 | PDTB123TK |
| PDTD123TS[1] | SOT54 | SC-43A | TO-92 | PDTB123TS |
| PDTD123TT | SOT23 | - | TO-236AB | PDTB123TT |

^[1] Also available in SOT54A and SOT54 variant packages (see Section 2).

1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 500 mA output current capability
- Reduces component count
- Reduces pick and place costs

1.3 Applications

- Digital application in automotive and industrial segments
- Controlling IC inputs

- Cost saving alternative for BC817 series in digital applications
- Switching loads

1.4 Quick reference data

Table 2. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---------------------------|------------|------|-----|------|------|
| V_{CEO} | collector-emitter voltage | open base | - | - | 50 | V |
| Io | output current | | - | - | 500 | mA |
| R1 | bias resistor 1 (input) | | 1.54 | 2.2 | 2.86 | kΩ |



2. Pinning information

Table 3. **Pinning** Simplified outline Pin **Description Symbol** SOT54 1 input (base) 2 output (collector) 3 GND (emitter) R1 001aab347 SOT54A 1 input (base) 2 output (collector) 3 GND (emitter) R1 001aab348 006aaa218 **SOT54** variant 1 input (base) 2 output (collector) 3 GND (emitter) R1 001aab447 006aaa218 **SOT23, SOT346** 1 input (base) 3 2 GND (emitter) 3 output (collector) 2 006aaa144 sym012

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3. Ordering information

Table 4. Ordering information

| Type number | Package | | | | | |
|--------------|---------|---|---------|--|--|--|
| | Name | Description | Version | | | |
| PDTD123TK | SC-59A | plastic surface mounted package; 3 leads | SOT346 | | | |
| PDTD123TS[1] | SC-43A | plastic single-ended leaded (through hole) package; 3 leads | SOT54 | | | |
| PDTD123TT | - | plastic surface mounted package; 3 leads | SOT23 | | | |

^[1] Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9).

4. Marking

Table 5. Marking codes

| Type number | Marking code ^[1] |
|-------------|-----------------------------|
| PDTD123TK | E9 |
| PDTD123TS | TD123TS |
| PDTD123TT | *1T |

^{[1] * = -:} made in Hong Kong

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|-----------------------------|-----|------------|------|
| V_{CBO} | collector-base voltage | open emitter | - | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 50 | V |
| V_{EBO} | emitter-base voltage | open collector | - | 5 | V |
| VI | input voltage | | | | |
| | positive | | - | +12 | V |
| | negative | | - | - 5 | V |
| I _O | output current | | - | 500 | mA |
| P _{tot} | total power dissipation | $T_{amb} \leq 25 ^{\circ}C$ | [1] | | |
| | SOT346 | | - | 250 | mW |
| | SOT54 | | - | 500 | mW |
| | SOT23 | | - | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |
| | | | | | |

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

PDTD123T_SER_3

^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

6. Thermal characteristics

Table 7. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------|---|-------------|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | | | |
| | SOT346 | | - | - | 500 | K/W |
| | SOT54 | | - | - | 250 | K/W |
| | SOT23 | | - | - | 500 | K/W |

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

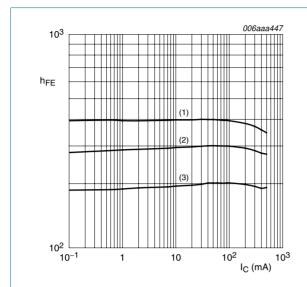
Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------------------|--------------------------------------|---|------|-----|------|------|
| I _{CBO} collector-ba | collector-base cut-off | $V_{CB} = 40 \text{ V}; I_{E} = 0 \text{ A}$ | - | - | 100 | nA |
| | current | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$ | - | - | 100 | nA |
| I _{CEO} | collector-emitter cut-off current | $V_{CE} = 50 \text{ V}; I_B = 0 \text{ A}$ | - | - | 0.5 | μΑ |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}$ | - | - | 100 | nA |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 50 \text{ mA}$ | 100 | 300 | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_C = 50 \text{ mA}; I_B = 2.5 \text{ mA}$ | - | - | 0.3 | V |
| R1 | bias resistor 1 (input) | | 1.54 | 2.2 | 2.86 | kΩ |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$ | - | 7 | - | pF |

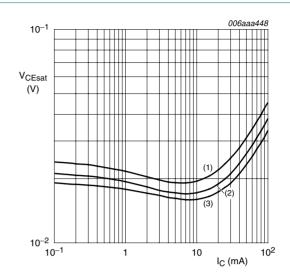
PDTD123T series

NPN 500 mA resistor-equipped transistors; R1 = 2.2 k Ω , R2 = open



- $V_{CE} = 5 V$
- (1) $T_{amb} = 100 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -40 \, ^{\circ}C$

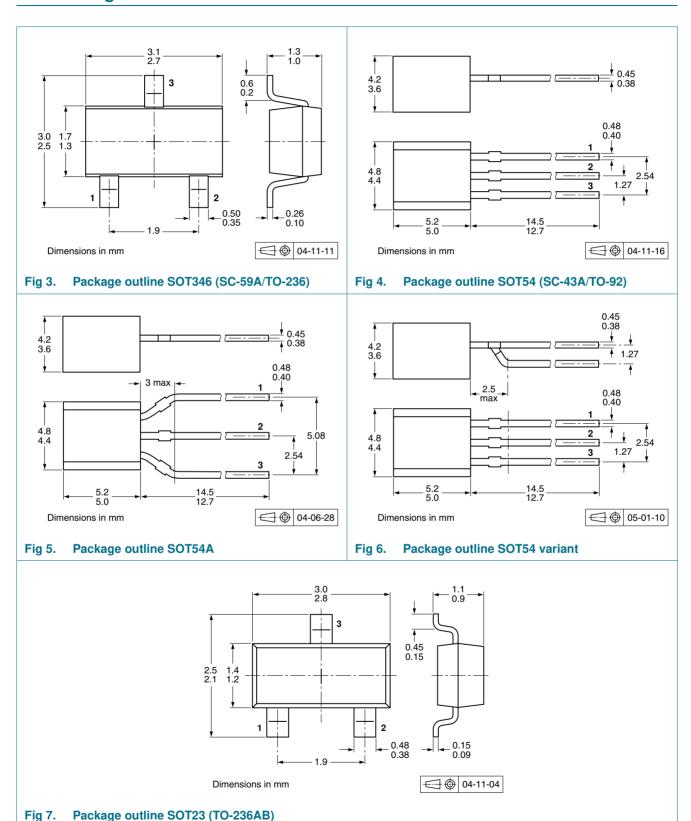
Fig 1. DC current gain as a function of collector current; typical values



- $I_{\rm C}/I_{\rm B} = 20$
- (1) $T_{amb} = 100 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -40 \, ^{\circ}C$

Fig 2. Collector-emitter saturation voltage as a function of collector current; typical values

8. Package outline



Product data sheet

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NPN 500 mA resistor-equipped transistors; R1 = 2.2 k Ω , R2 = open

Packing information 9.

Packing methods Table 9.

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing quantity | | | |
|-------------|---------------|--------------------------------|------------------|------|-------|--|
| | | | 3000 | 5000 | 10000 | |
| PDTD123TK | SOT346 | 4 mm pitch, 8 mm tape and reel | -115 | - | -135 | |
| PDTD123TS | SOT54 | bulk, straight leads | - | -412 | - | |
| | SOT54A | tape and reel, wide pitch | - | - | -116 | |
| | | tape ammopack, wide pitch | - | - | -126 | |
| | SOT54 variant | bulk, delta pinning | - | -112 | - | |
| PDTD123TT | SOT23 | 4 mm pitch, 8 mm tape and reel | -215 | - | -235 | |

^[1] For further information and the availability of packing methods, see Section 12.



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NPN 500 mA resistor-equipped transistors; R1 = 2.2 k Ω , R2 = open

10. Revision history

Table 10. Revision history

Product data sheet

| | • | | | |
|----------------|--------------|--|---------------|----------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| PDTD123T_SER_3 | 20091116 | Product data sheet | - | PDTD123T_SER_2 |
| Modifications: | | eet was changed to reflect v legal definitions and disc | | |
| PDTD123T_SER_2 | 20050721 | Product data sheet | - | PDTD123T_SER_1 |
| PDTD123T_SER_1 | 20050603 | Product data sheet | - | - |

11. Legal information

11.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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PDTD123T series

NPN 500 mA resistor-equipped transistors; R1 = 2.2 k Ω , R2 = open

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